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SECTION 3: STANDARD PROCEDURES AND PRACTICES (SPP)

3.1 Background

JEDEC Publication (JEP) No. 95, section 4 is the JEDEC Design Guidelines. It is the repository for requirements for all package outlines. The preparation of Design Guidelines is a continuing process; therefore, there is a need to introduce specific requirement statements prior to the release of the actual Design Guideline. This is accomplished using Standard Procedures and Practices that are contained in section 3 of JEP95.

3.2 Procedure

- 1) Initial draft prepared by subcommittee, task group, or individual sponsor from a member company
- 2) Main Committee review and approval to conduct standards ballot.
- 3) Sponsor-prepared letter ballot distributed for formal voting.
- 4) Subcommittee or Task Group review of ballot results, with reballoting if necessary.
- 5) Main Committee review and approval to submit to Board of Directors.
- 6) Sponsor-prepared JEDEC Council ballot distributed to Council members for formal voting.
- 7) JEDEC Council review of ballot results.
- 8) JEDEC Council approval to publish.
- 9) Preparation of final drawing by individual sponsor from a member company.
- 10) Final JC-11 Editorial review.
- 11) Release of Standard Procedures and Practices and publication by JEDEC Office.